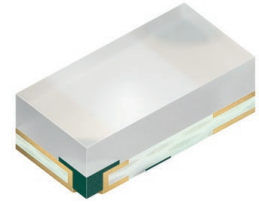


LT QH9G

CHIPLED® 0402



Applications

- Electronic Equipment
- Gaming, Amusement, Gambling
- Health Monitoring (Heart Rate Monitoring, Pulse Oximetry)
- Textile Illumination
- White Goods

Features:

- Package: SMT package 0402, colorless diffused resin
- Chip technology: InGaN on Sapphire
- Typ. Radiation: 115° (horizontal), 170° (vertical)
- Color: $\lambda_{\text{dom}} = 530 \text{ nm}$ (● true green)
- Optical efficacy: 38 lm/W
- Corrosion Robustness Class: 3B
- ESD: 1 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)

Ordering Information

Type	Luminous Intensity ¹⁾ $I_F = 5 \text{ mA}$ I_v	Ordering Code
LT QH9G-Q200-25-2Z4Y	$\geq 90 \text{ mcd}$	Q65111A7377

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 85 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 85 °C
Junction Temperature	T_j	max.	90 °C
Forward current $T_A = 25\text{ °C}$	I_F	max.	15 mA
Surge Current $t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_A = 25\text{ °C}$	I_{FS}	max.	100 mA
Reverse voltage ²⁾ $T_A = 25\text{ °C}$	V_R	max.	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	V_{ESD}		1 kV

Characteristics

$I_F = 5 \text{ mA}$; $T_A = 25 \text{ °C}$

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	525 nm
Dominant Wavelength ³⁾	λ_{dom}	min.	520 nm
		typ.	530 nm
		max.	540 nm
Spectral Bandwidth at 50% $I_{\text{rel,max}}$	$\Delta\lambda$	typ.	33 nm
Viewing angle at 50% I_V values for 0°, 90°	2φ	typ.	115 °
		typ.	170 °
Forward Voltage ⁴⁾ $I_F = 5 \text{ mA}$	V_F	min.	2.50 V
		typ.	2.85 V
		max.	3.10 V
Reverse current ²⁾ $V_R = 12 \text{ V}$	I_R	max.	10 μA
Real thermal resistance junction/ambient ⁵⁾⁶⁾	$R_{\text{thJA real}}$	typ.	570 K / W
		max.	700 K / W
Real thermal resistance junction/solderpoint ⁵⁾	$R_{\text{thJS real}}$	typ.	350 K / W
		max.	480 K / W

Brightness Groups

Group	Luminous Intensity ¹⁾ $I_F = 5 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 5 \text{ mA}$ max. I_v	Luminous Flux ⁷⁾ $I_F = 5 \text{ mA}$ typ. Φ_v
Q2	90 mcd	112 mcd	300 mlm
R1	112 mcd	140 mcd	380 mlm
R2	140 mcd	180 mcd	480 mlm
S1	180 mcd	224 mcd	610 mlm
S2	224 mcd	280 mcd	760 mlm
T1	280 mcd	355 mcd	950 mlm
T2	355 mcd	450 mcd	1210 mlm

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ $I_F = 5 \text{ mA}$ min. V_F	Forward Voltage ⁴⁾ $I_F = 5 \text{ mA}$ max. V_F
2Z	2.50 V	2.60 V
3X	2.60 V	2.70 V
3Y	2.70 V	2.80 V
3Z	2.80 V	2.90 V
4X	2.90 V	3.00 V
4Y	3.00 V	3.10 V

Wavelength Groups

Group	Dominant Wavelength ³⁾ min. λ_{dom}	Dominant Wavelength ³⁾ max. λ_{dom}
2	520 nm	525 nm
3	525 nm	530 nm
4	530 nm	535 nm
5	535 nm	540 nm

Group Name on Label

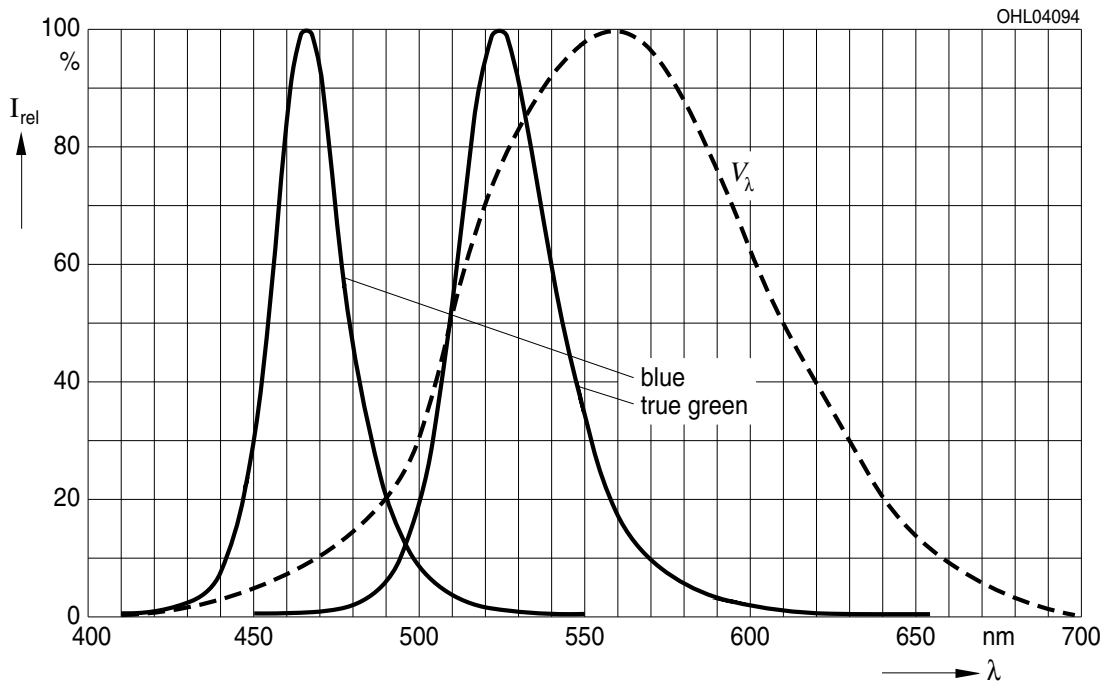
Example: Q2-2-2Z

Group Name on Label

Brightness	Wavelength	Forward Voltage
Q2	2	2Z

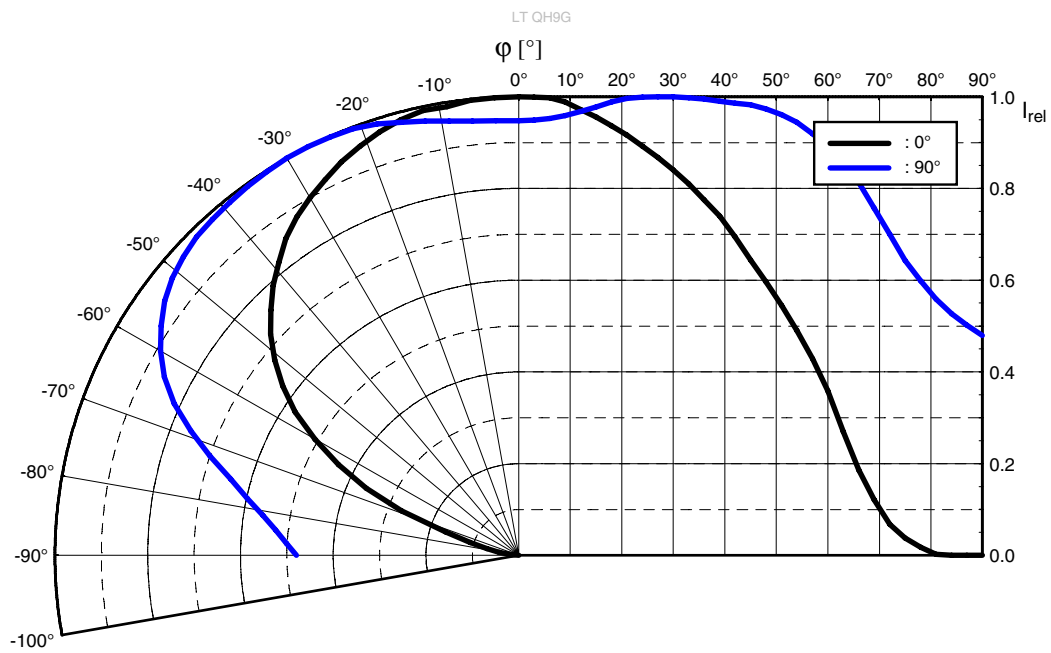
Relative Spectral Emission ⁷⁾

$I_{rel} = f(\lambda); I_F = 5 \text{ mA}; T_A = 25 \text{ }^\circ\text{C}$



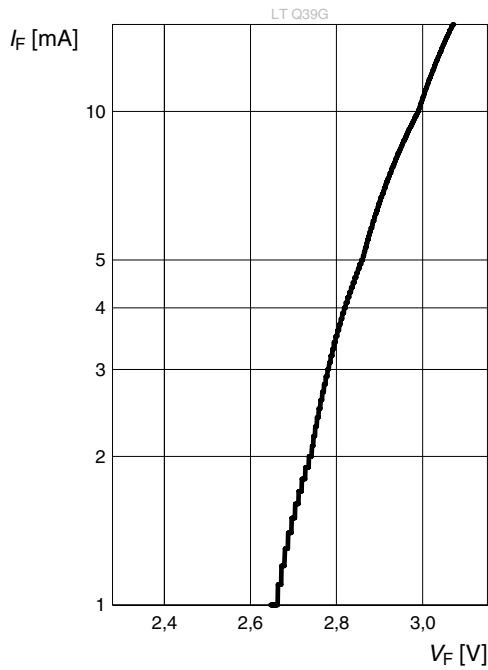
Radiation Characteristics ⁷⁾

$I_{rel} = f(\phi); T_A = 25 \text{ }^\circ\text{C}$



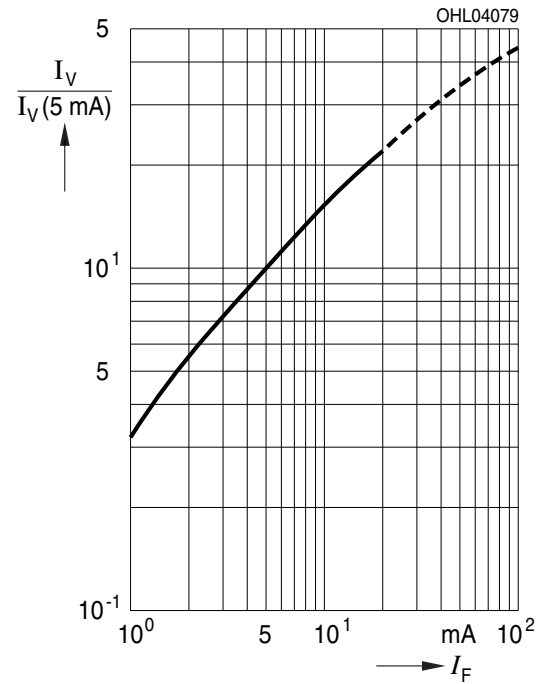
Forward current 7), 8)

$I_F = f(V_F); T_A = 25\text{ }^\circ\text{C}$



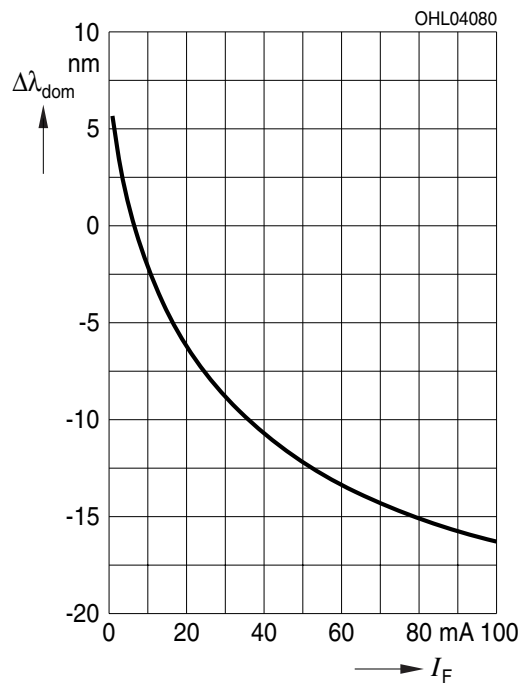
Relative Luminous Intensity 7), 8)

$I_V/I_V(5\text{ mA}) = f(I_F); T_A = 25\text{ }^\circ\text{C}$



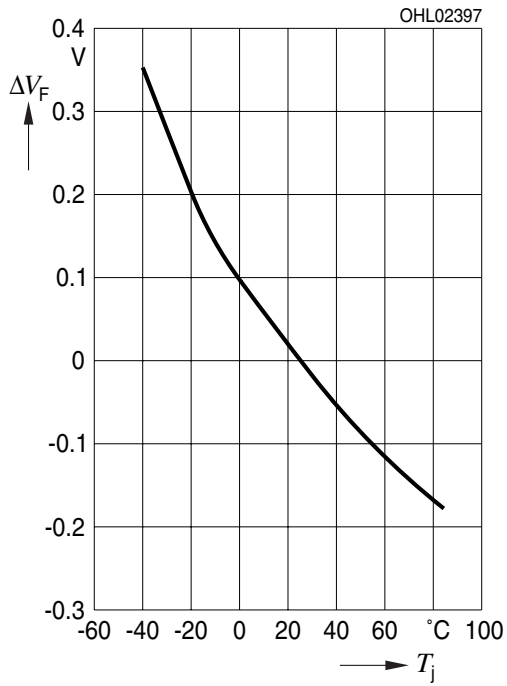
Dominant Wavelength 7)

$\Delta\lambda_{\text{dom}} = f(I_F); T_A = 25\text{ }^\circ\text{C}$



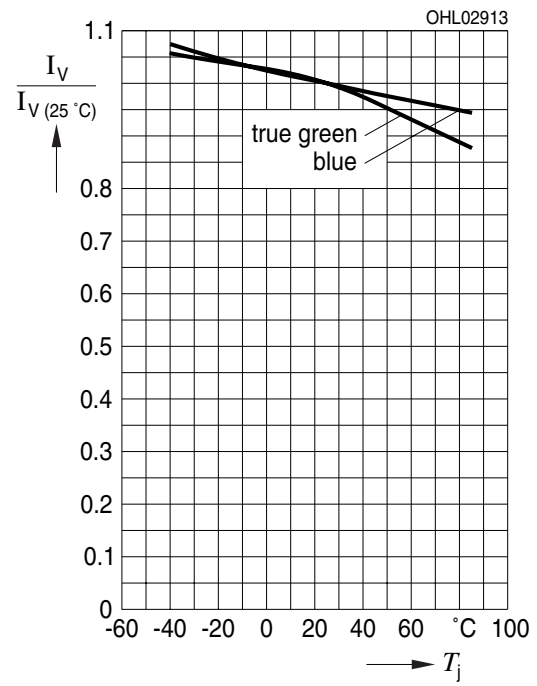
Forward Voltage ⁷⁾

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 5\text{ mA}$$



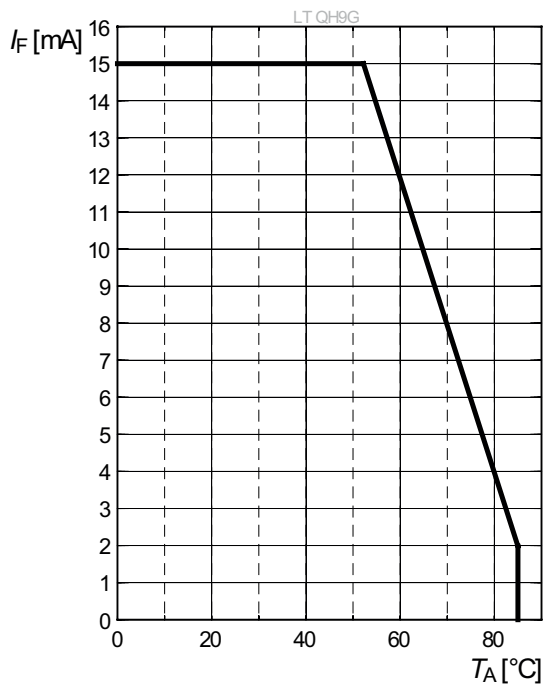
Relative Luminous Intensity ⁷⁾

$$I_V/I_V(25\text{ °C}) = f(T_j); I_F = 5\text{ mA}$$



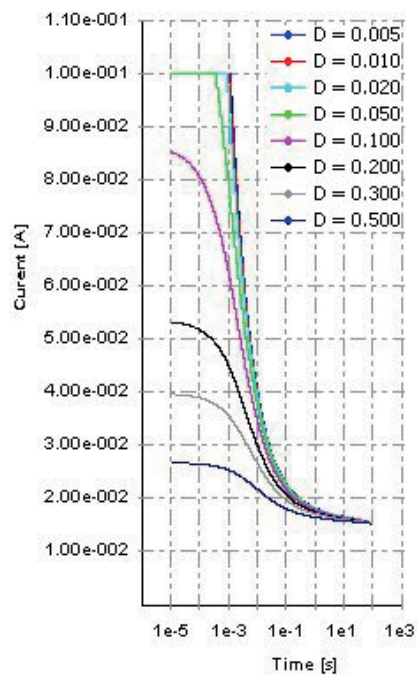
Max. Permissible Forward Current

$$I_F = f(T)$$



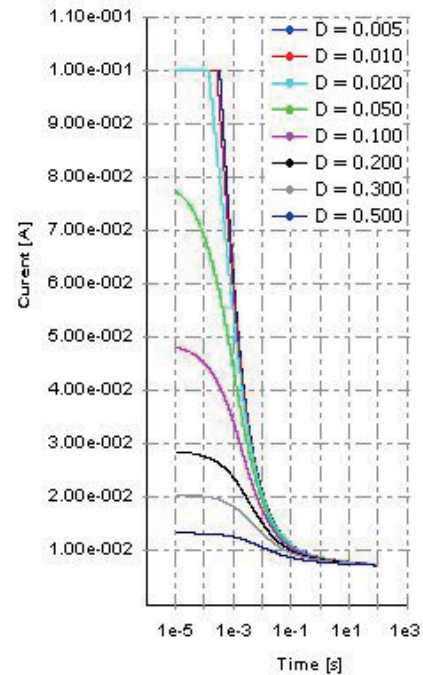
Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_A = 25^\circ\text{C}$$

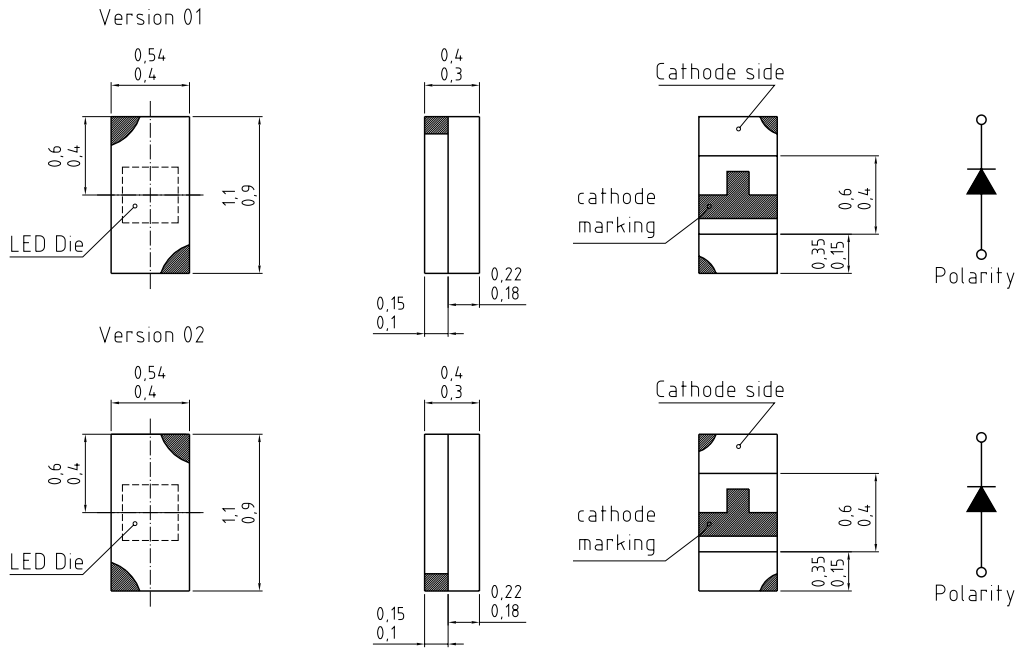


Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_A = 85^\circ\text{C}$$



Dimensional Drawing ⁹⁾



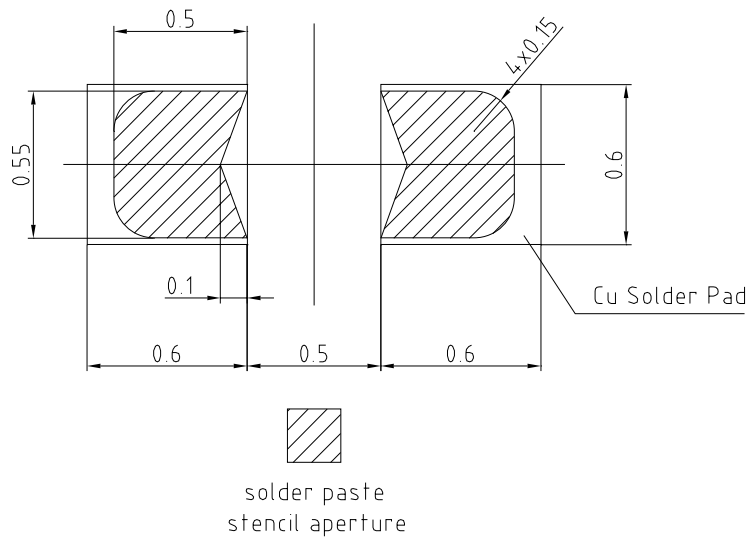
C63062-A4025-A1. -04

Further Information:

Approximate Weight: 0.4 mg

Corrosion test: Class: 3B
 Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC 60068-2-43)

Recommended Solder Pad ⁹⁾

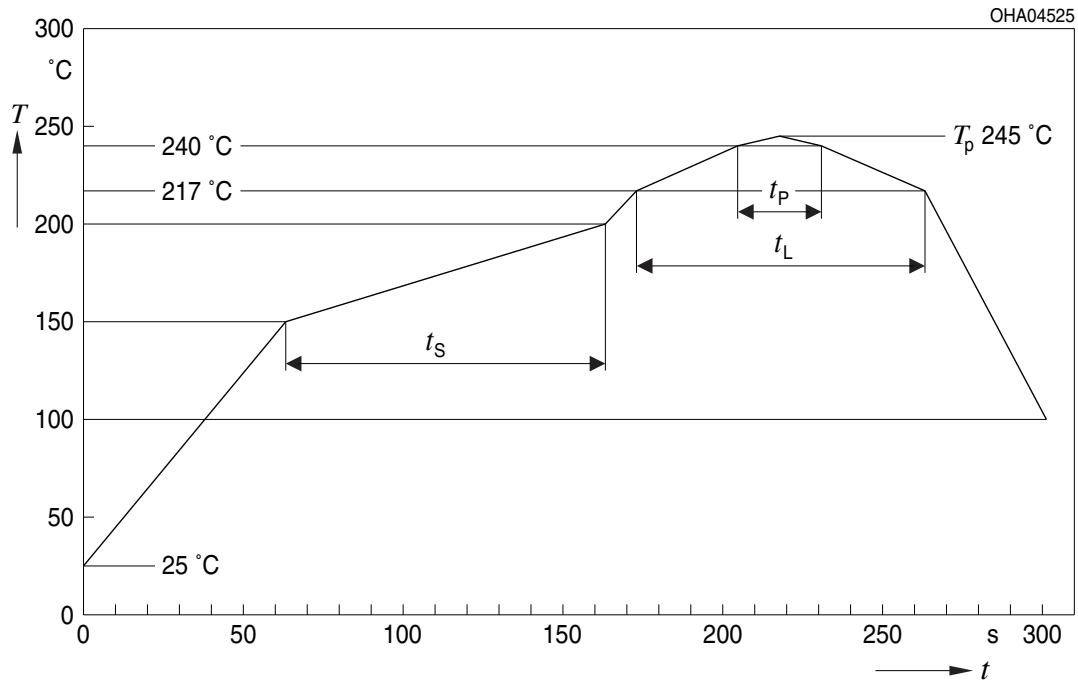


E062 3010 70 -50

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

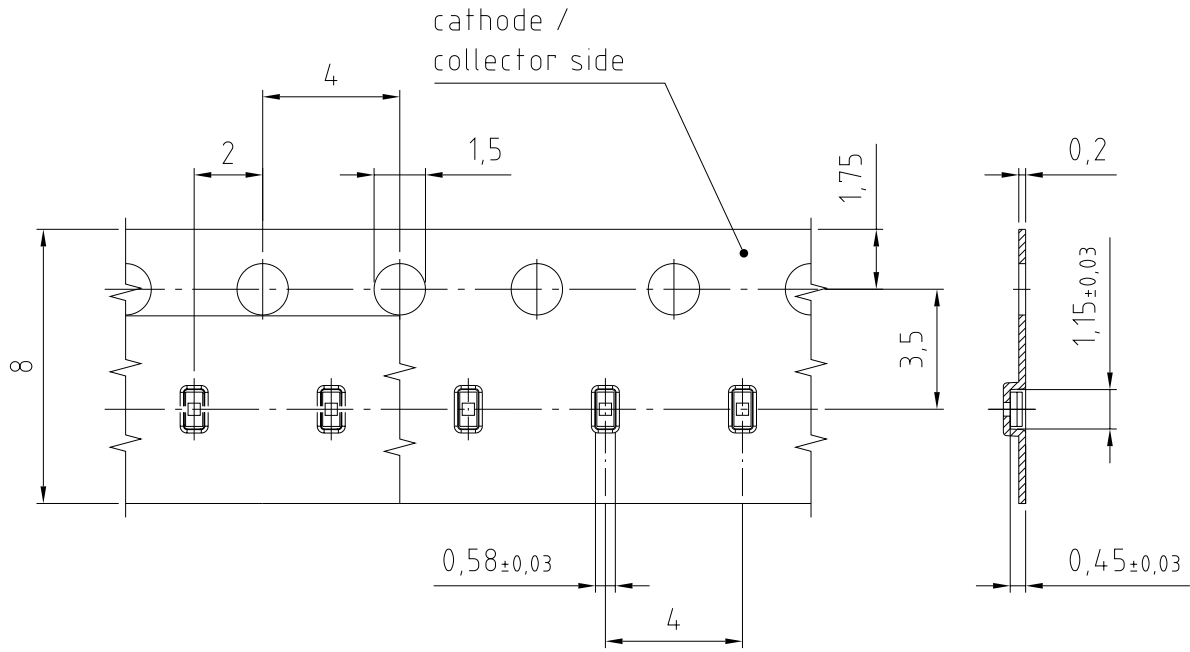


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁹⁾



C63062-A4025-B1-05

Tape and Reel ¹⁰⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	4000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST
X XXX °C X

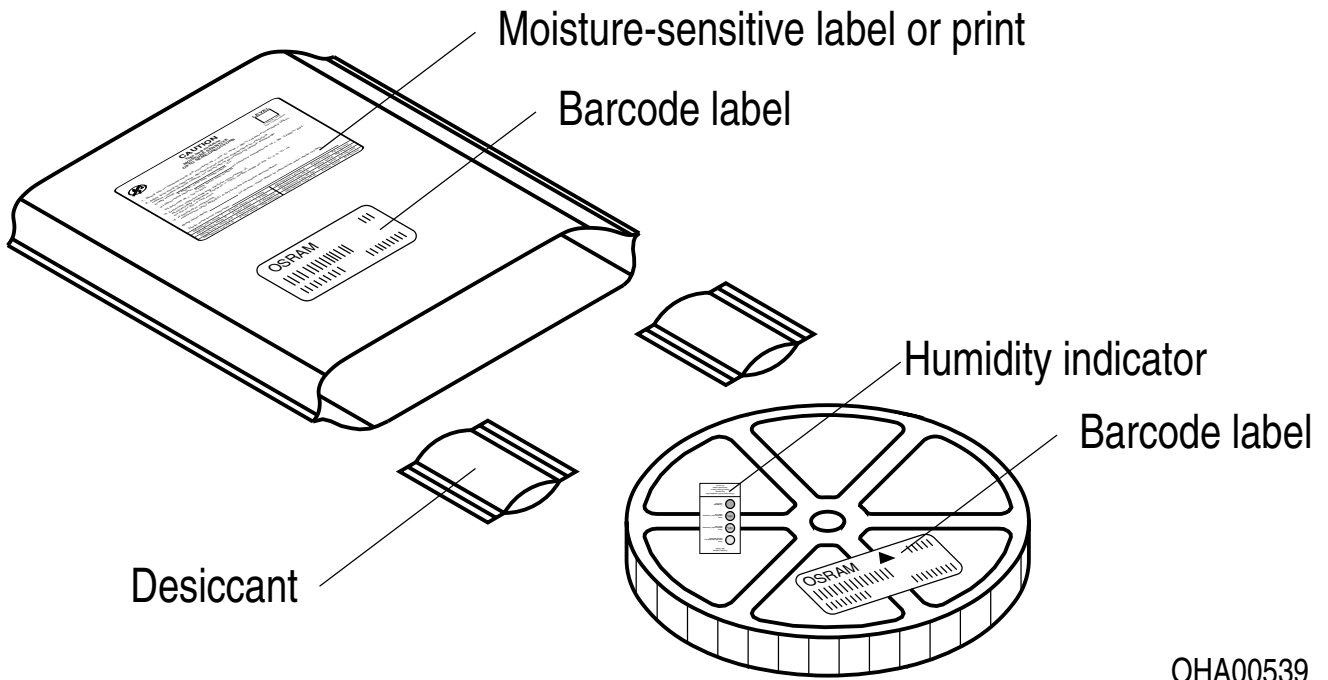
(1T) LOT NO: 1234567890 (9D) D/C: 1234 Pack: RXX
DEMY XXX
X_X123_1234.1234 X

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below the logo is a 'RoHS Compliant' statement. The label features three horizontal barcode sections. The first is labeled '(6P) BATCH NO: 1234567890' and is associated with 'ML Temp ST X XXX °C X'. The second is labeled '(1T) LOT NO: 1234567890' and '(9D) D/C: 1234', with a 'no liquid' symbol and 'Pack: RXX', 'DEMY XXX', and 'X_X123_1234.1234 X' below it. The third is labeled '(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X'. A QR code is located on the right side of the label.

OHA04563

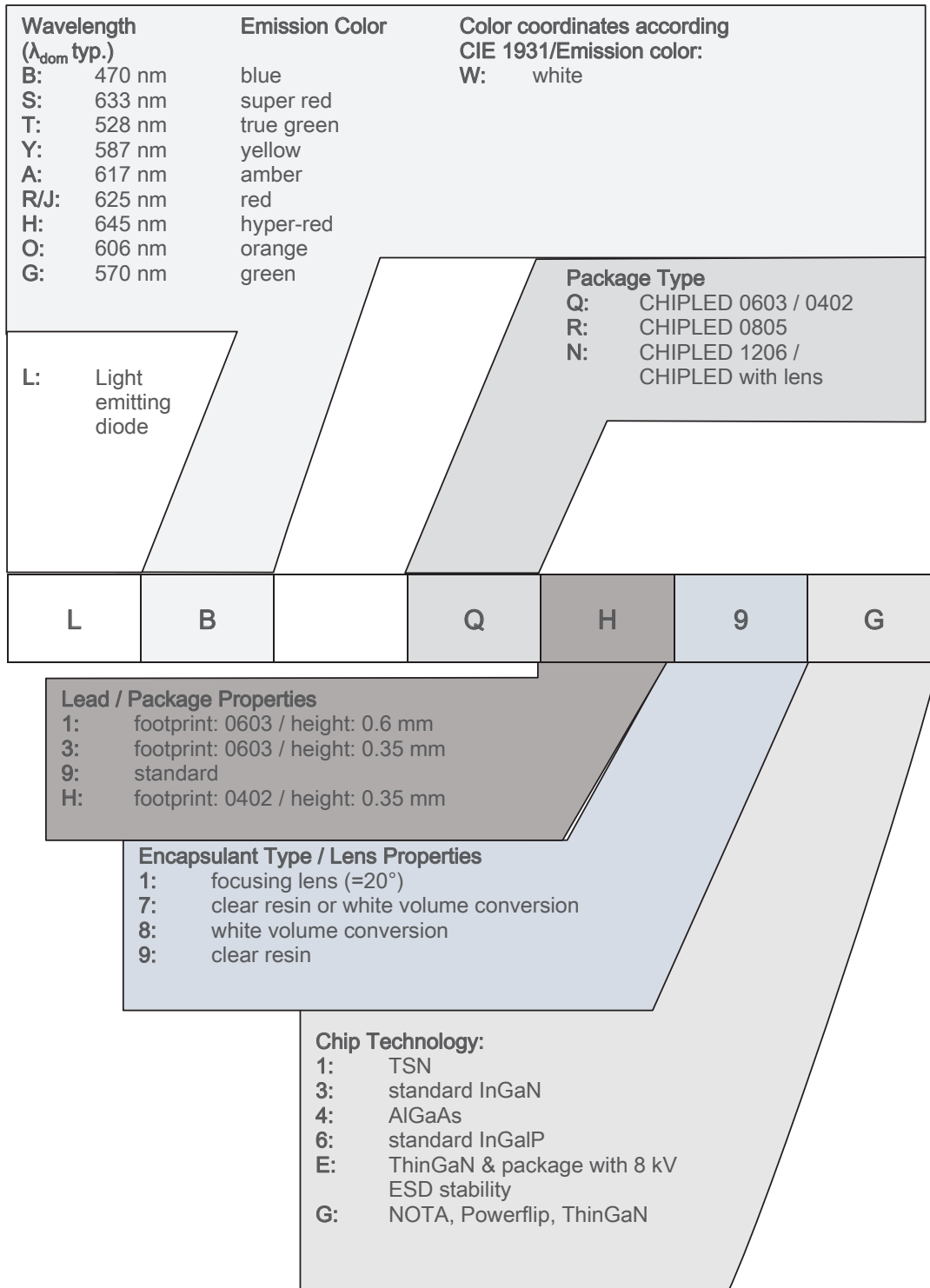
Dry Packing Process and Materials ⁹⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Based on very short life cycle times in chip technology this component is subject to frequent adaption to the latest chip technology.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of $\pm 11\%$.
- 2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 3) **Wavelength:** Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ± 1 nm.
- 4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.1 V.
- 5) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 6) **Thermal Resistance:** R_{thJA} results from mounting on PC board FR 4 (pad size ≥ 5 mm² per pad)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.4	2020-01-17	Dimensional Drawing Taping
1.5	2020-02-11	Taping

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